

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Phase-out/Discontinued

μPA1500B

**N-CHANNEL POWER MOS FET ARRAY
SWITCHING USE**

DESCRIPTION

The μPA1500B is N-channel Power MOS FET Array that built in 4 circuits and surge absorber designed for solenoid, motor and lamp driver.

FEATURES

- 4 V driving is possible
- Large Current and Low On-state Resistance
 $I_{D(DC)} = \pm 3 \text{ A}$
 $R_{DS(on)1} \leq 0.18 \Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 2 \text{ A)}$
 $R_{DS(on)2} \leq 0.24 \Omega \text{ MAX. (} V_{GS} = 4 \text{ V, } I_D = 2 \text{ A)}$
- Low Input Capacitance $C_{iss} = 200 \text{ pF TYP.}$
- Surge Absorber, built in

ORDERING INFORMATION

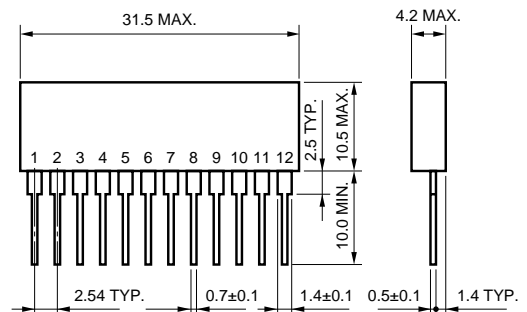
Type Number	Package
μPA1500BH	12 Pin SIP

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	V_{DSS} Note 1	60	V
Gate to Source Voltage	V_{GSS} Note 2	±20	V
Drain Current (DC)	$I_{D(DC)}$	±3.0	A/unit
Drain Current (pulse)	$I_{D(pulse)}$ Note 3	±12	A/unit
Repetitive peak Reverse Voltage	V_{RRM} Note 4	65	V
Diode Forward Current	$I_{F(av)}$ Note 4	3.0	A/unit
Total Power Dissipation	P_{T1} Note 5	28	W
Total Power Dissipation	P_{T2} Note 6	4.0	W
Channel Temperature	T_{CH}	150	°C
Storage Temperature	T_{stg}	-55 to 150	°C
Single Avalanche Current	I_{AS} Note 7	3.0	A
Single Avalanche Energy	E_{AS} Note 7	0.9	mJ

- Notes**
1. $V_{GS} = 0$
 2. $V_{DS} = 0$
 3. $PW \leq 10 \mu s, \text{ Duty Cycle} \leq 1 \%$
 4. Rating of Surge Absorber
 5. 4 Circuits, $T_C = 25 \text{ °C}$
 6. 4 Circuits, $T_A = 25 \text{ °C}$
 7. Starting $T_{CH} = 25 \text{ °C}$, $V_{DD} = 30 \text{ V}$, $V_{GS} = 20 \text{ V} \rightarrow 0$,
 $R_G = 25 \Omega$, $L = 100 \mu H$

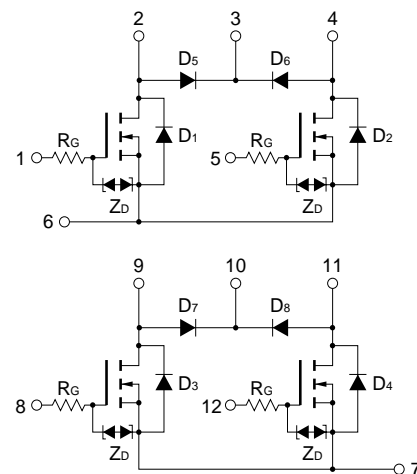
**PACKAGE DIMENSIONS
(in millimeters)**



ELECTRODE CONNECTION

- 1, 5, 8, 12 GATE
- 2, 4, 9, 11 DRAIN, ANODE
- 6, 7 SOURCE
- 3, 10 CATHODE

CONNECTION DIAGRAM



- D1 to D4 : Body Diode
- D5 to D8 : Surge Absorber
- Zb : Gate to Source Protection Diode
- R_G : Gate Input Resistance 330 Ω TYP.

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

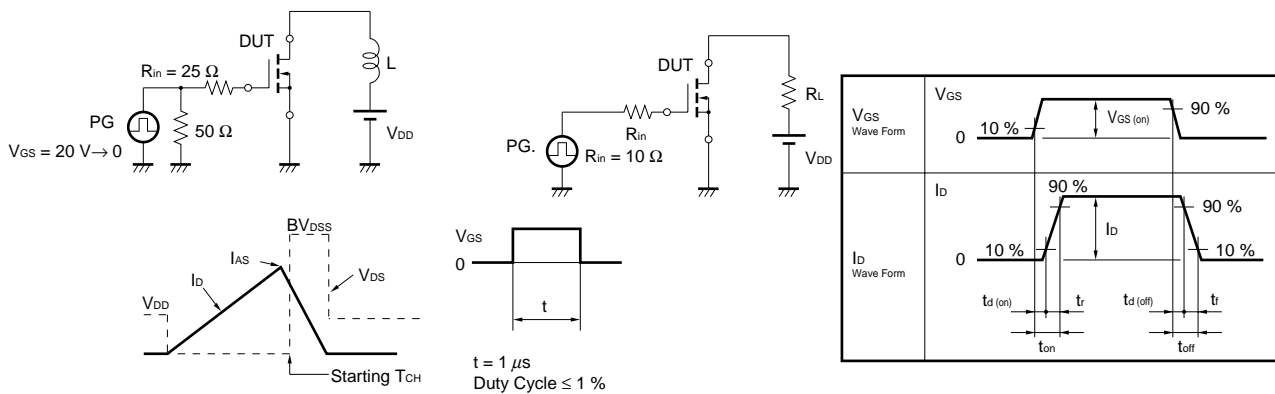
ELECTRICAL CHARACTERISTICS (T_A = 25 °C)

CHARACTERISTIC	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Leakage Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0			10	μ A
Gate Leakage Current	I _{GSS}	V _{GS} = \pm 20 V, V _{DS} = 0			\pm 10	μ A
Gate Cutoff Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1.0 mA	1.0		2.0	V
Forward Transfer Admittance	Y _{fs}	V _{GS} = 10 V, I _D = 2.0 A	2.0			S
Drain to Source On-State Resistance	R _{DS(on)1}	V _{GS} = 10 V, I _D = 2.0 A		0.10	0.18	Ω
	R _{DS(on)2}	V _{GS} = 4.0 V, I _D = 2.0 A		0.14	0.24	Ω
Input Capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0, f = 1.0 MHz		200		pF
Output Capacitance	C _{oss}			150		pF
Reverse Transfer Capacitance	C _{rss}			55		pF
Turn-on Delay Time	t _{d(on)}	I _D = 2.0 A, V _{GS} = 10 V, V _{DD} = 30 V, R _L = 15 Ω		20		ns
Rise Time	t _r			100		ns
Turn-off Delay Time	t _{d(off)}			735		ns
Fall Time	t _f			350		ns
Total Gate Charge	Q _G	V _{GS} = 10 V, I _D = 3.0 A, V _{DD} = 48 V		13		nC
Gate to Source Charge	Q _{GS}			2		nC
Gate to Drain Charge	Q _{GD}			4.7		nC
Body Diode Forward Voltage	V _{F(S-D)}	I _F = 3 A, V _{GS} = 0		1.0		V

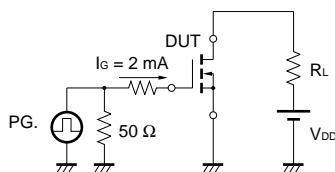
SURGE ABSORBER (Diode, builtin) 1 Unit

Repetitive peak Reverse Current	I _{RRM}	V _R = 65 V			10	μ A
Diode Forward Voltage	V _F	I _F = 3.0 A			1.5	V

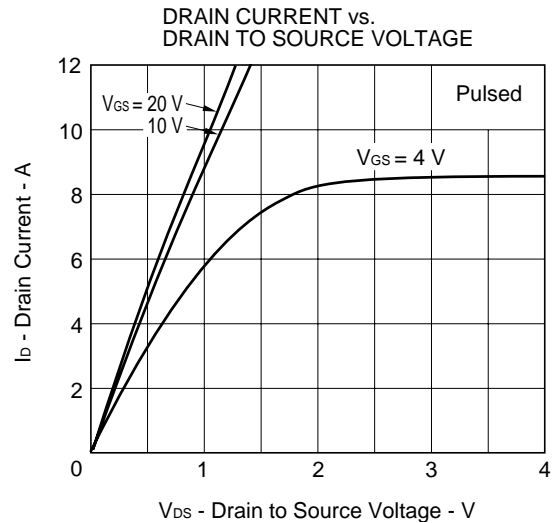
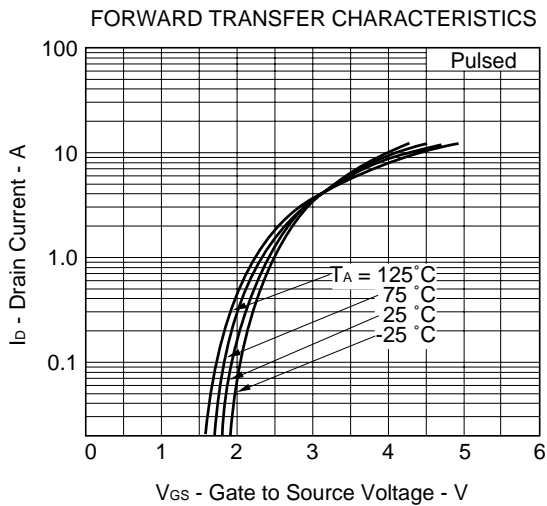
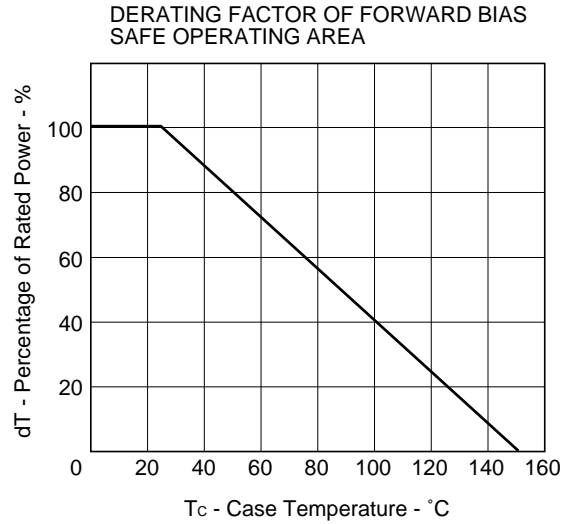
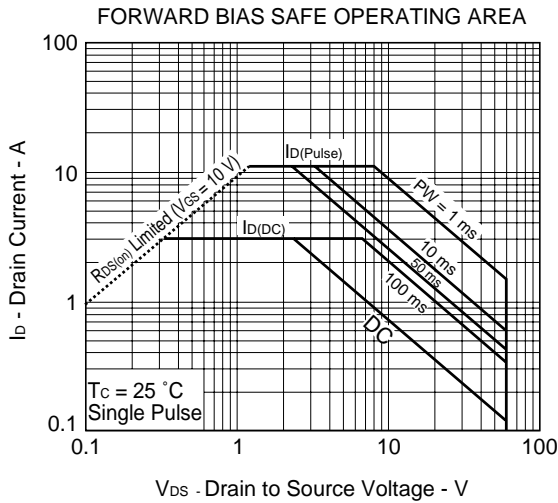
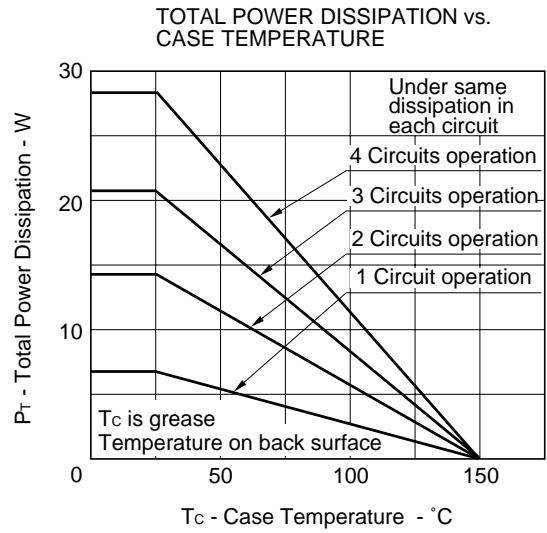
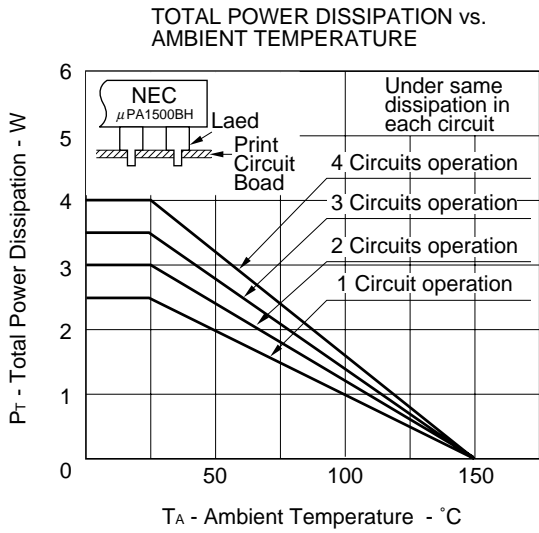
Test Circuit 1 Avalanche Capability Test Circuit 2 Switching Time



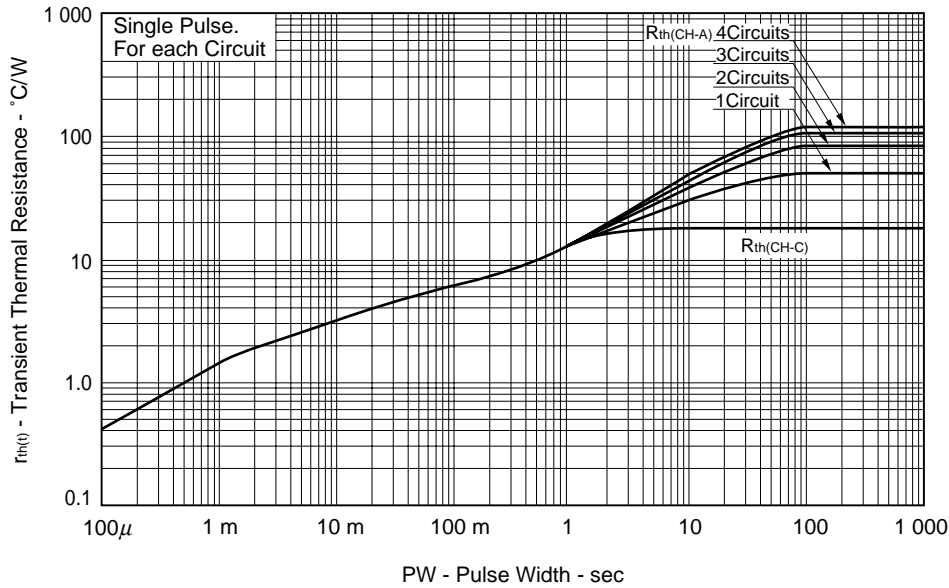
Test Circuit 3 Gate Charge



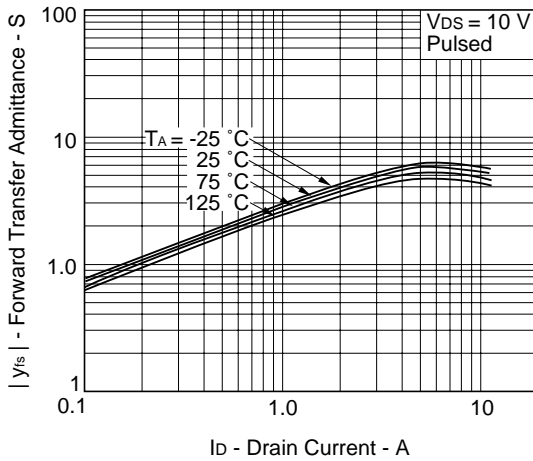
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)



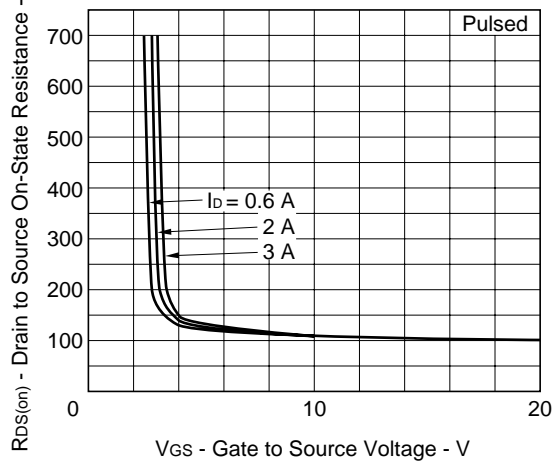
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



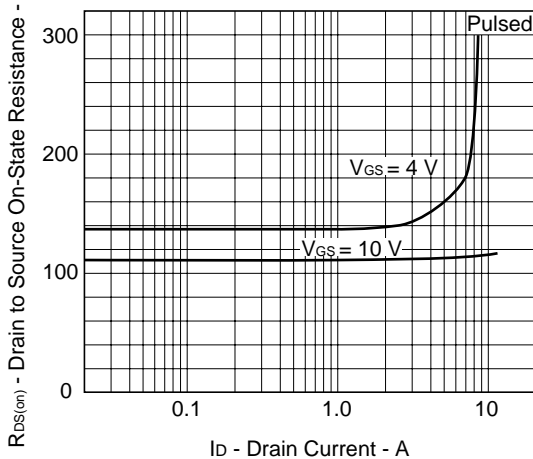
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



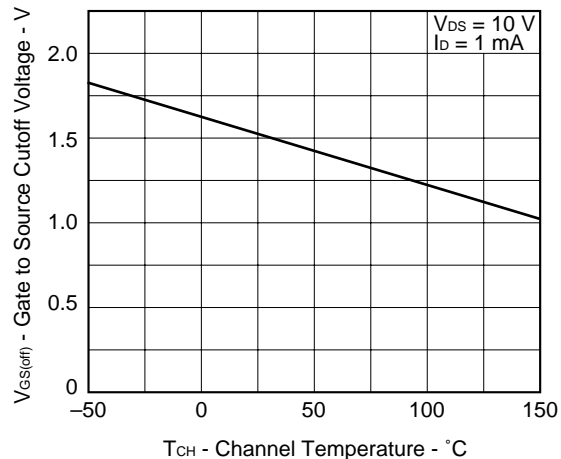
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

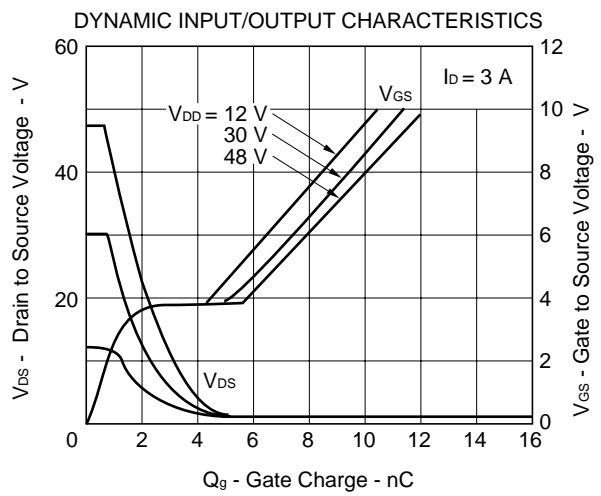
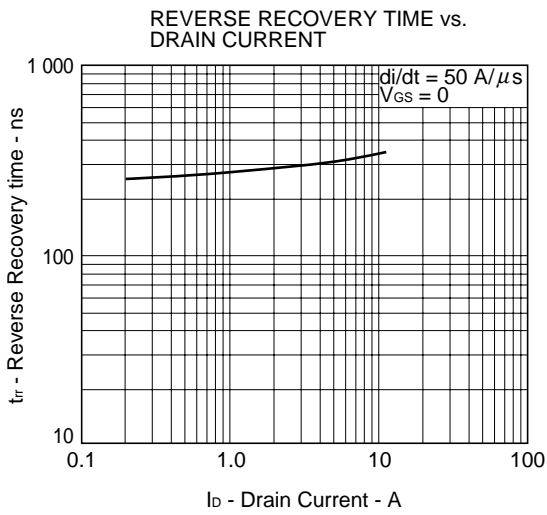
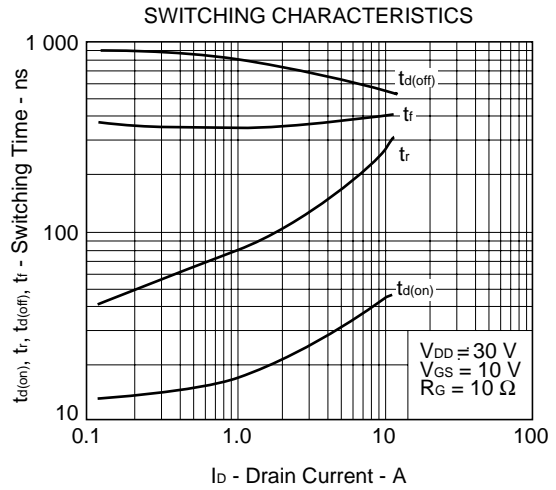
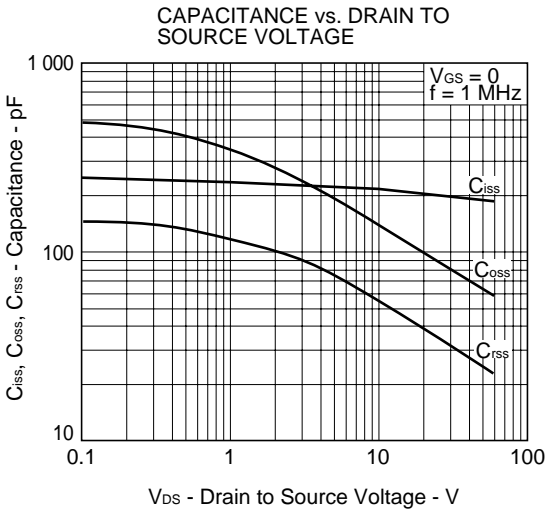
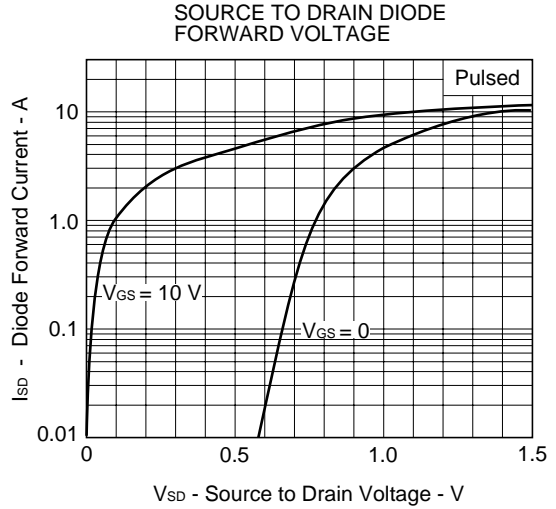
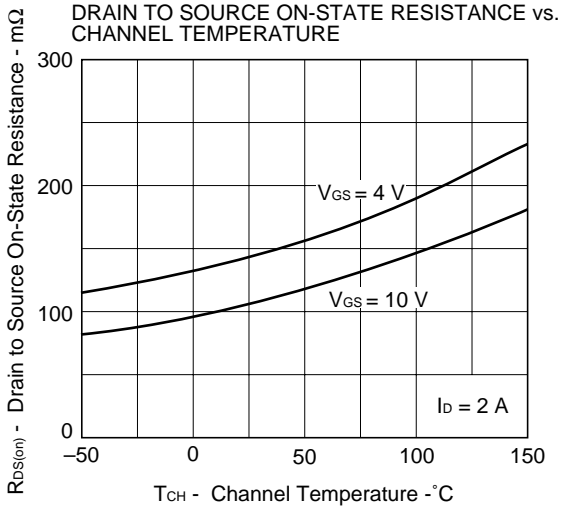


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

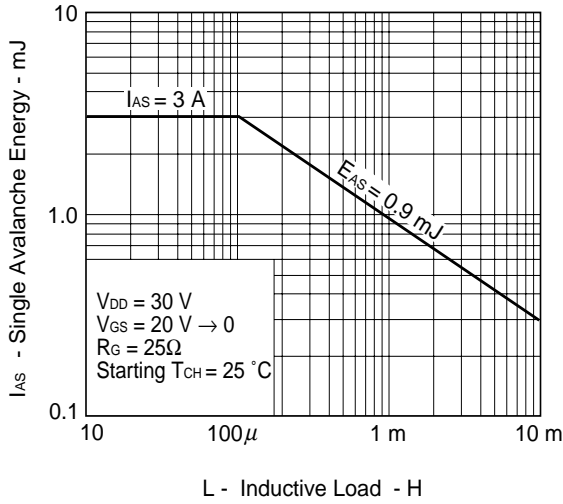


GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

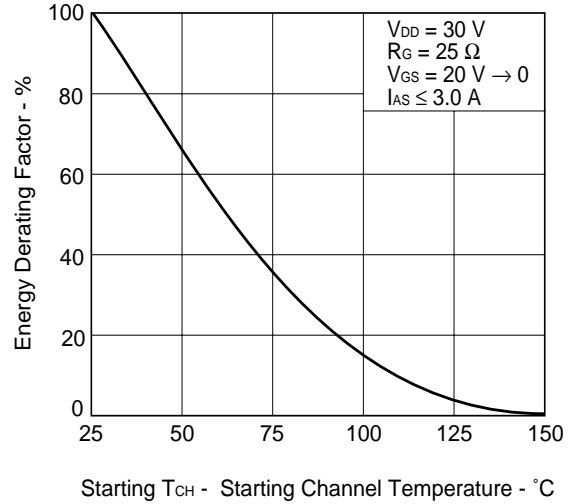




SINGLE AVALANCHE ENERGY vs. INDUCTIVE LOAD



SINGLE AVALANCHE ENERGY DERATING FACTOR



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system	TEI-1202
Quality grade on NEC semiconductor devices	IEI-1209
Semiconductor device mounting technology manual	IEI-1207
Semiconductor device package manual	IEI-1213
Guide to quality assurance for semiconductor devices	MEI-1202
Semiconductor selection guide	MF-1134
Power MOS FET features and application switching power supply	TEA-1034
Application circuits using Power MOS FET	TEA-1035
Safe operating area of Power MOS FET	TEA-1037

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